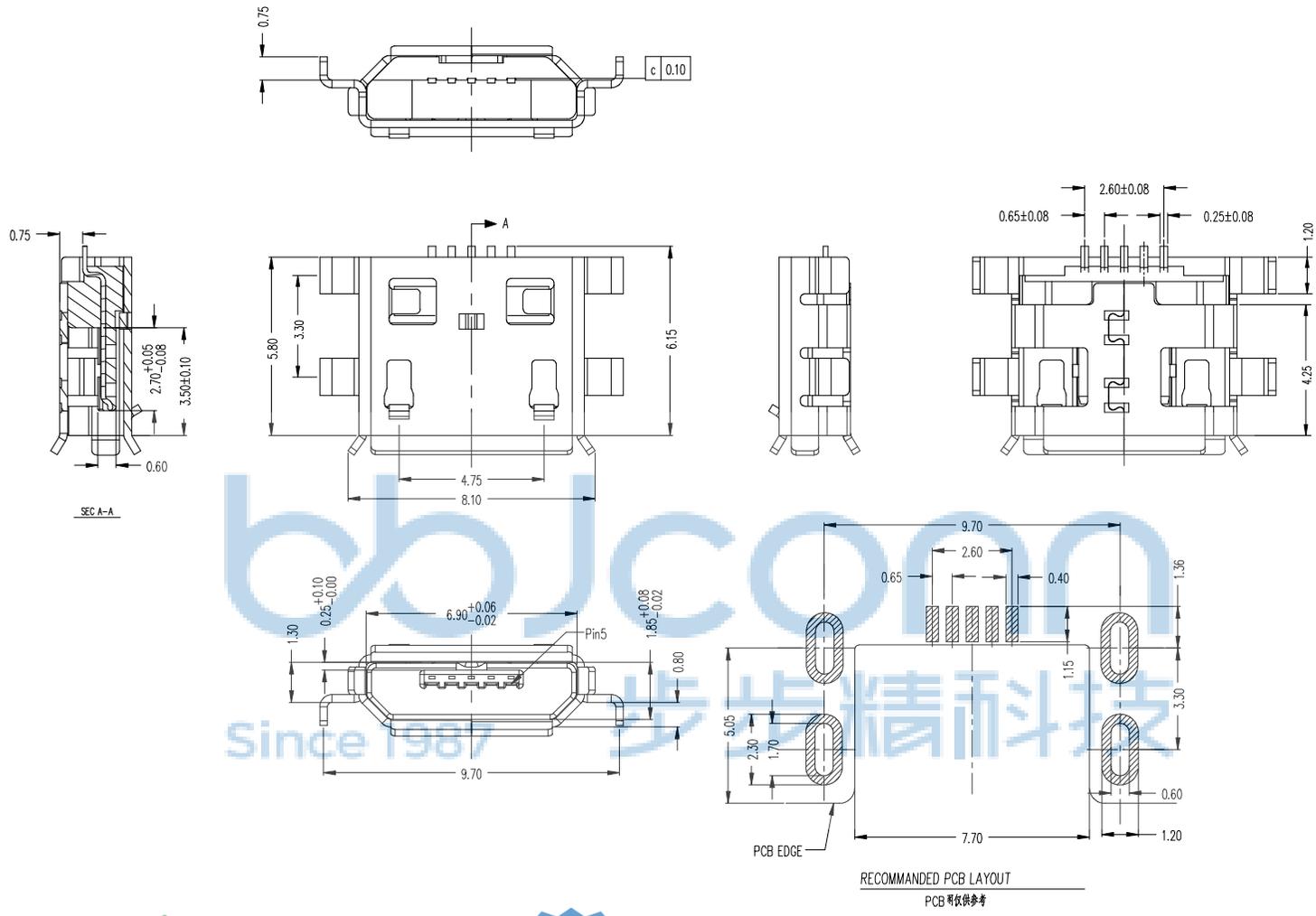


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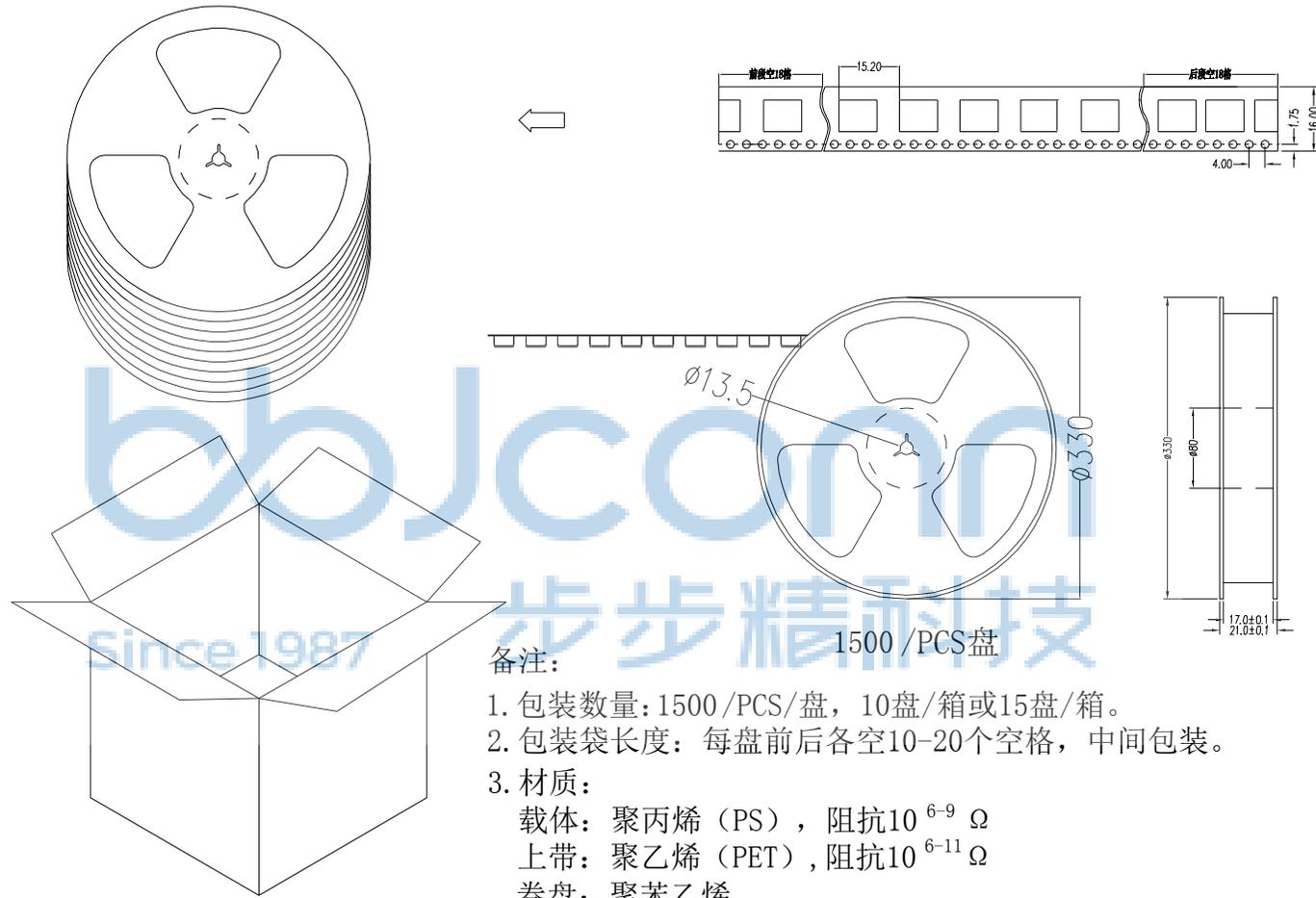


- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f,UL94v-0
 - Contact: copper alloy,t=0.15mm
 - Shell: SUS/copper alloy,t=0.25mm
 - Specification:
 - Current rating: 1,5PIN 1.8A Max/2,3,4PIN 1A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min.
 - Temperature range: -30°C~80°C



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CORPORATION AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		NAME: MICRO- 5p 母座 四脚插 L=5.80 沉板0.8 卷边 铜壳	PJ. NO.: MC.01.71-11-1005 SIZE: A4 DRW NO.:
APPD. JM_Zheng 23/05'02	CHKD. LYX 23/05'02	FINISH: SEE NOTES	MAT'L.: SEE NOTES
PDWG.NO: 0113-1	DR. SGF 23/05'02	SCALE: N/A	REV.: A3 UNIT: mm PAGE: 1/1

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备注：
1. 包装数量：1500 /PCS/盘，10盘/箱或15盘/箱。
2. 包装袋长度：每盘前后各空10-20个空格，中间包装。
3. 材质：
载体：聚丙烯（PS），阻抗 $10^{6-9} \Omega$
上带：聚乙烯（PET），阻抗 $10^{6-11} \Omega$
卷盘：聚苯乙烯。

纸箱规格：345*345*23MM
纸箱规格：345*345*35MM



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APPD.	JM_Zheng	23/05'02	PJ. NO.: MC.01.71-11-1005 SIZE: A4 DRW NO.:		
CHKD.	LYX	23/05'02	FINISH: SEE NOTES MAT'L.: SEE NOTES		
PDWG.NO:	0113-1	DR.	SGF	23/05'02	SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/1